HOT SOLDER
ALL 24 AWG
DIPPED

METAL MICRO-D STRAIGHT
BOARD MOUNT CONDENSED
W/ O-RING/GASKET

GENDER
1 = RECEPTACLE, SOCKET CONTACTS
2 = PLUG, PIN CONTACTS

NUMBER OF CONTACTS
009  025  051
015  031  069
021  037  100

SHELL HARDWARE
0 = NO HARDWARE
3 = JACKPOST (.040 PANEL MOUNT)
4 = JACKPOST (.060 PANEL MOUNT)
5 = JACKPOST (.070 PANEL MOUNT)
6 = JACKPOST (.080 PANEL MOUNT)

SHELL FINISH
A = CADMIUM
B = ELECTROLESS NICKEL
C = O-RING CONDUCTIVE
D = O-RING DIELECTRIC
S = SQ GASKET CONDUCTIVE

TERMINATION
1 = .109 ±.015
2 = .140 ±.015
3 = .172 ±.015
4 = .190 ±.015
5 = .250 ±.015
6 = .125 ±.015

ALL 24 AWG
HOT SOLDER
DIPPED
MDV PLUG PCB LAYOUTS

* SIZES 9-37:.100 X .075 GRID PATTERN OFFSET BY .050
** SIZES 51-100:.075 X .075 GRID PATTERN OFFSET BY .0375

TOLERANCE: .XXX ± .005
      .XX ± .01
      ANGLE ± 1°